

# ATC 3750-A6CR

High Performance NVIDIA® Jetson AGX Orin™  
Edge AI Computer for Railway Applications



## Main Features

- ♦ Built-in NVIDIA® Jetson AGX Orin™ SOM, up to 200/275 INT8 Sparse TOPS AI performance
- ♦ Designed to be fanless, rugged, and compact
- ♦ 6 x GbE PoE+ port for IP CAM/LiDAR sensors, optional 1 x 10GbE port
- ♦ HEVC/H.265 hardware decode, supports up to 7 x 4K30
- ♦ Wide range operating temperature of -25°C~70°C (OT3)
- ♦ Ultra-speed PCIe 4.0 x4 NVMe SSD for data integrity

- ♦ Expandable for GNSS, LTE/5G NR & Wi-Fi 5/6
- ♦ 24V DC-in for rail, ignition control & OCP/OVP
- ♦ NEXCOM Acceleration Linux (NAL) integrated w/ JetPack 6.1
- ♦ Military standard of MIL-STD-810H for anti-vibration/shock
- ♦ CE/FCC, UKCA, EN 50155 (EN 55011, EN 50121-3-2, EN 61373, OT3, EN 45545) certified

## Product Overview

AI has become an essential component of automated vehicle technologies. With its built-in high performance NVIDIA® Jetson AGX Orin™ SOM, the ATC 3750-A6CR can deliver up to 200/275 TOPS workload on Artificial Intelligence (AI) processing and inference, supporting applications such as ADAS in Transportation/Construction, ANPR, AMR, Machine Learning (ML), ITS and factory automation.

Thanks to NEXCOM's excellent thermal solutions, the ATC 3750-A6CR can work through its defined TDP (15W to 60W) in harsh environments without a fan kit to achieve 200/275 TOPS workload performance.

The ATC 3750-A6CR is a rugged, compact-size in-vehicle AI powered computer that features DC 24V (power isolation) with IGN control, 6 PoE+ (X-coded) for accessing IP CAM/LiDAR sensors, and rich peripheral ports, USB 3.2, isolation CAN bus, RS-232, Console, DI/DO, OTG and HDMI®. With the installation of 5G NR, Wi-Fi 5/6 modules, the ATC 3750-A6CR can collaborate with CPS for AI model re-training, making it suitable for deployment in sophisticated applications such as ADAS/ANPR/Alaied ITS/Construction, etc. In harsh environments, the ATC 3750-A6CR can operate at a wide temperature range of -25°C to 70°C and meet the MIL-STD-810H military standard for anti-vibration and shock. For regulation, the ATC 3750-A6CR is certified by CE/FCC Class A, UKCA, EN 45545 and EN 50155.

## Specifications

### NVIDIA® Jetson AGX Orin™ SOM

- ♦ Jetson AGX Orin™ 32GB
  - CPU: 8-core Arm® Cortex®-A78AE v8.2 64-bit, 2MB L2 + 4MB L3
  - GPU: 1792-core NVIDIA® Ampere architecture with 56 Tensor Cores
  - Memory: 32GB 256-bit LPDDR5, 204.8GB/s
  - AI performance: 200 INT8 Sparse TOPS
  - 2 x NVDLA v2.0 engines: 1.4 GHz, 46 INT8 Sparse TOPS each
  - Video encode: 1 x 4K60/3 x 4K30/6 x 1080p60/12 x 1080p30 (H.265)
  - Video decode: 1 x 8K30/2 x 4K60/4 x 4K30/9 x 1080p60/18 x 1080p30 (H.265)
- ♦ Jetson AGX Orin™ 64GB
  - CPU: 12-core Arm® Cortex®-A78AE v8.2 64-bit, 3MB L2 + 6MB L3
  - GPU: 2048-core NVIDIA® Ampere architecture with 64 Tensor Cores
  - Memory: 64GB 256-bit LPDDR5, 204.8GB/s
  - AI performance: 275 INT8 Sparse TOPS
  - 2 x NVDLA v2.0 engines: 1.6 GHz, 52.5 INT8 Sparse TOPS each
  - Video encode: 2 x 4K60/4 x 4K30/8 x 1080p60/16 x 1080p30 (H.265)
  - Video decode: 1 x 8K30/3 x 4K60/7 x 4K30/11 x 1080p60/22 x 1080p30 (H.265)
- ♦ OpenGL 4.6+, OpenGL ES 3.2, CUDA® 10.2+, and Vulkan 1.2+
- ♦ NVIDIA® JetPack 6.1

### Storage

- ♦ 64GB eMMC 5.1 flash storage, 200MHz (HS400 or HS533)
- ♦ 1 x Accessible SD card (SDXC-I/UHS-I, SD 3.0)
- ♦ 1 x M.2 Key M 2280 (PCIe 4.0 x4) NVMe SSD

### Expansion

- ♦ 1 x Full size Mini PCIe **socket** (PCIe 4.0, USB 2.0)
- ♦ 1 x M.2 Key B 3042/3052 **socket** (USB 3.2/2.0), 2 x nano-SIM **slot**
- ♦ 1 x M.2 Key E 3030 **socket** (PCIe 4.0, USB 2.0) for Wi-Fi 5/6

### Display

- ♦ 1 x HDMI® 2.0a/b, up to 3840x2160@60Hz

### G-Sensor

- ♦ 3D accelerometer and 3D gyroscope, ST LSM6DSLTR

### PoE+

- ♦ 6 x **GbE port, M12-X-coded connector**
  - 9Kbyte Jumbo frame
  - IEEE 802.3af/at, total 80W
  - IEEE1588 supported
  - PSE on/off & Watt monitoring
  - GIGA LAN switch: KSZ9477STXI

### USB

- ♦ 2 x USB 3.2 Gen 2, Type-A
  - 5V@900mA each
  - Up to 10Gbit/s link speed & compliance with USB 2.0 (LS/FS/HS link speed)
- ♦ 1 x OTG, Micro-USB

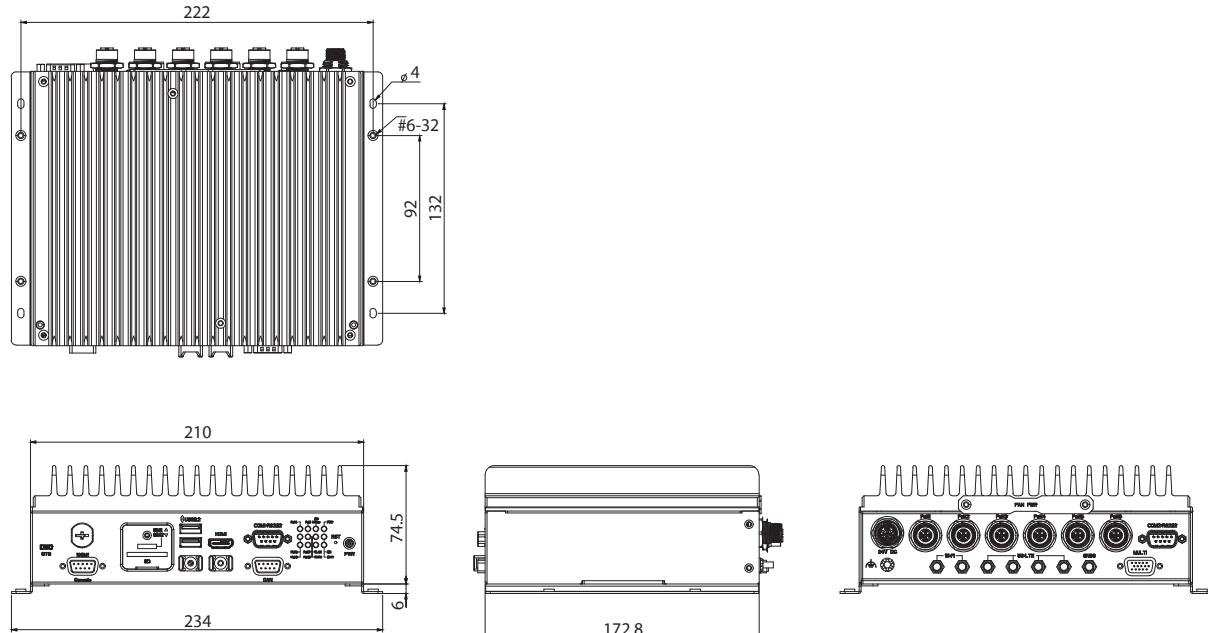
### Serial Port

- ♦ 2 x RS-232 (Tx, Rx, RTS, CTS)
- ♦ 1 x Console (Tx, Rx)
- ♦ RS-232 working voltage ± 9V, baud rate up to 115.2kb/s

### DI/DO

- ♦ 4-bit input
- ♦ Source: DC 9V~36V (12V@1.1mA/24V@2.2mA)
  - External: DC 0V~33V pull-high, high-level, DC 3.3V~33V; low-level, DC 0V~2V
- ♦ 4-bit output
- ♦ Source: DC 9V~36V (nominal 35mA@24V)

## Dimension Drawing



- External: DC 5V~27V pull-high, sink current w/ 220mA for each bit, 500mA max (@25C)
- ♦ Source or external can be selected by software (default: source type)

### CAN bus

- ♦ 2 x CAN FD, compatible with CAN 2.0A/2.0B
- ♦ IEC 61000-4-2 Electrostatic Discharge (ESD): ± 8kV/15kV (contact/air)
- ♦ Up to 5Mb/s in data transmit, 2.5kV isolated

### 10GbE, X-coded (optional)

- ♦ Ethernet PHY: Marvell AQR113C-BO-I
- ♦ 10GBASE-T/5GBASE-T/2.5GBASE-T/1000BASE-T/100BASE-TX/10BASE-T
- ♦ Compliant with IEEE 802.3az
- ♦ 9Kbyte Jumbo frame
- ♦ IEEE 1588 supported

### Watch Dog Timer

- ♦ Yes, through MCU

### Remote ATX PWR & Reset Trigger

- ♦ Reserved, wafer-type

### GNSS

- ♦ u-blox NEO-M9N GNSS module for GPS/Gloness/QZSS/Galileo/Beidou
- ♦ Optional DR (Dead Reckoning) function

### Power Supply (K-coded)

- ♦ Nominal voltage: DC 24V (14.4V~33.6V), K-coded connector
- ♦ OCP & UVP (shut down once exceeding 37V)
- ♦ Ignition on/off control & programmable on/off delay timer
- ♦ Optional for remote power on/off control

### I/O Ports, Front-Plate

- ♦ 1 x ATX power button
- ♦ 1 x Reset button
- ♦ 12 x LED Indicator
- ♦ 2 x USB 3.2, Type-A
- ♦ 1 x Console (DB9)
- ♦ 2 x CAN (DB9)
- ♦ 1 x COM1/RS-232 (DB9)
- ♦ 2 x nano-SIM
- ♦ 1 x HDMI®
- ♦ 1 x SD
- ♦ 1 x OTG

### I/O Ports, Rear-Plate

- ♦ 1 x COM2/RS-232 (DB9)
- ♦ 6 x X-coded (GbE PoE+)
- ♦ 1 x Multi (DI/DO, DR signal)
- ♦ 1 x SMA for GNSS

- ♦ 2 x RP-SMA for Wi-Fi
- ♦ 4 x SMA for LTE/5G
- ♦ 24V DC-in

### Dimension & Weight

- ♦ Dimensions: 234.0mm (W) x 172.8mm (D) x 80.5mm (H)  
w/ mount bracket
- ♦ weight: 3.5kg

### Environment

- ♦ Operating temperature: -25°C~70°C (OT3) (TDP 15W~60W, fanless, w/ 80W PoE)
- ♦ Storage temperature: -40°C~85°C
- ♦ Relative humidity: 10%~95% (non-condensing)

### Vibration & Shock

- ♦ Vibration in operating:
  - MIL-STD-810H, 514.8C Procedure 6, Category 4
  - IEC 60068-2-64: 2.0g@5Hz~500Hz
- ♦ Vibration in storage:
  - MIL-STD-810G, 514.6E Procedure 1, Category 24, 7.7g
- ♦ Shock:
  - MIL-STD-810G, 516.6 Procedure I, trucks and semi-trailers=40g
  - Crash hazard: Procedure V, ground equipment=75g

### Certifications

- ♦ CE approval, FCC Class A, UKCA, EN 45545 and EN 50155 certified

### Operating System

- ♦ NEXCOM Aided Linux (NAL) w/ Jetpack 6.1 integrated
  - NEXCOM custom functions (GNSS, 5G/NR, 6-axis sensor, MCU control)
  - Ubuntu 22.04 (L4T 36.3, Linux Kernel 5.15)

### External Cable (optional)

- ♦ DB15 multi-port adapter cable, 20cm

## Ordering Information

- ♦ **ATC 3750-A6CR (P/N: 10AT0375002X0)**  
NVIDIA® Jetson AGX Orin™ 32GB, 64GB eMMC, 6 x PoE+ (X-coded), 2 x USB 3.2, 2 x RS-232, OTG/Console, DC 24V for rail

- ♦ **ATC 3750-A6CR-64 (P/N: 10AT0375003X0)**  
NVIDIA® Jetson AGX Orin™ 64GB, 64GB eMMC, 6 x PoE+ (X-coded), 2 x USB 3.2, 2 x RS-232, OTG/Console, DC 24V for rail

- ♦ **VTK PWA20-01 (P/N: 10VK00PWA01X0)**  
DC/DC converter 24V, 200W, w/ power isolation, A-coded to K-code adapter cable